

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5322121

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YEOW KHOON TAN	10/10/2017
RECEIVING PARTY DATA	
Name:	SH TECHNOLOGIES PTE LTD
Street Address:	1 BUROH CRESCENT #07-01
Internal Address:	COGENT 1.LOGISTICS HUB
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	627545
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16317431
CORRESPONDENCE DATA	
Fax Number:	(323)983-0869
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	323-983-2293
Email:	info@jciplawyers.com
Correspondent Name:	JCIP
Address Line 1:	1055 WEST 7TH STREET
Address Line 2:	33RD FLOOR
Address Line 4:	LOS ANGELES, CALIFORNIA 90017
ATTORNEY DOCKET NUMBER:	YSA1-PN.060-JGC
NAME OF SUBMITTER:	JOSEPH G. CHU
SIGNATURE:	/joseph g. chu/
DATE SIGNED:	01/11/2019
Total Attachments: 7	
source=YSA1PN060JGC_Assignment#page1.tif	
source=YSA1PN060JGC_Assignment#page2.tif	
source=YSA1PN060JGC_Assignment#page3.tif	
source=YSA1PN060JGC_Assignment#page4.tif	

source=YSA1PN060JGC_Assignment#page5.tif

source=YSA1PN060JGC_Assignment#page6.tif

source=YSA1PN060JGC_Assignment#page7.tif

DATED the 10 day of October 2017

TAN YEOW KHOON

as Assignor

And

SH TECHNOLOGIES PTE. LTD.

as Assignee

DEED OF ASSIGNMENT
Of
Inventions, Patents & Patent Applications

YUSARN AUDREY
24 Raffles Place
#27-01 Clifford Centre
Singapore 048621
Tel (65) 6358 2865
Fax (65) 6358 2864
Email: enquiries@yusarn.com

PATENT
REEL: 047973 FRAME: 0247



CONTENTS

<u>CLAUSE</u>	<u>HEADING</u>	<u>PAGE</u>
1.	ASSIGNMENT	3
2.	GENERAL	4
3.	GOVERNING LAW	4

SCHEDULES

1.	INVENTIONS	5
2.	PATENTS AND PATENT APPLICATIONS	6



THIS DEED is made on the 10 day of October 2017

BETWEEN

- (1) **TAN YEOW KHOON** (Singapore NRIC No. S0048987E), a citizen of the Republic of Singapore having his registered address at 128 Cove Drive Singapore 098265 (the "Assignor"); and
- (2) **SH TECHNOLOGIES PTE. LTD.** (Company Registration No. 201622885G), a company of the Republic of Singapore having its registered address at 1 Buroh Crescent #07-01 Cogent 1 Logistics Hub Singapore 627545 (the "Assignee").

WHEREAS:

- (A) The Assignor is the proprietor and beneficial owner of the inventions and all improvements, modifications and development of the inventions as specified in Schedule 1 (hereinafter collectively referred to as the "Inventions").
- (B) The Inventions may form part or whole of any patents and patent applications, including but not limited to those listed in Schedule 2 (hereinafter called the "Patents" and "Patent Applications").
- (C) The Assignor has agreed to assign to the Assignee the inventions, Improvements, Patents, Patent Applications and other such intellectual property rights on the terms set out in this Deed of Assignment.

NOW THIS DEED HEREBY WITNESSES as follows:

1. **ASSIGNMENT**

In consideration of the sum of S\$1, the Assignor hereby **ASSIGNS** absolutely to the Assignee free from encumbrances:

- (a) all their rights, titles and interests, present or future, throughout the world in and to:
 - (i) the Inventions, Patents and Patent Applications;
 - (ii) any improvements, modifications and development (the "Improvements") on the Inventions, Patents and Patent Applications heretofore or hereafter made or acquired by the Assignors (or any of them);
 - (iii) all intellectual property rights in the Inventions and Improvements;
 - (iv) all divisional, continuation and continuation-in-part patent applications in respect of the Inventions or any part thereof and/or any Improvements or any part thereof;



(v) the full and exclusive benefit of the Patent Applications to the intent that the grant of any patents should thereon be in the name of and vest in the Assignee; and

(vi) any and all patent or patents on the Inventions and/or Improvements that may be granted anywhere in the world,

together with all rights and powers arising or accrued therefrom including the right to sue for damages and other remedies in respect of any infringement of such rights or other acts within the scope of the claims of any published specification of any patent on the Inventions and/or Improvements;

(b) the right to apply for, prosecute and obtain patent or other similar forms of protection throughout the world, including but not limited to any divisional, continuation or continuation-in-part patent applications, in respect of the invention and/or the Improvements to the intent that the grant of any patents or similar protection shall be in the name of and vest in the Assignee; and

(c) the right to make any new application or applications in respect of any part or parts of the subject matter of any application or specification filed in connection with the Inventions and the right to claim priority from the Patent Applications or part thereof anywhere in the world.

2. GENERAL

2.1 This Deed may be executed in two or more counterparts, each of which shall be an original but all of which together shall constitute one and the same Deed.

2.2 If any provision or term of this Deed shall become or be declared illegal, invalid or unenforceable for any reason whatsoever, such term or provision shall be divisible from this Deed and shall be deemed to be deleted from this Deed to the extent of such prohibition or unenforceability without invalidating the remaining provisions hereof, provided always that if such deletion substantially affects or alters the commercial basis of this Deed the parties shall negotiate in good faith to amend and modify the provisions and terms of this Deed so as to achieve so far as possible the same economic effect without rendering the Deed so amended or modified illegal, invalid or unenforceable.

2.3 This Deed binds and benefits the respective successors, inheritors, assigns, and personal representatives of the Parties.

3. GOVERNING LAW

3.1 Governing law: This Deed shall be governed by and construed in accordance with the laws of Singapore.

3.2 Jurisdiction: The parties hereby submit to the non-exclusive jurisdiction of the Singapore courts.



SCHEDULE 1

Abstract of the Inventions

A system for assembling a plurality of pre-fabricated components to form a structure comprising: a first lifting device for transporting at least one pre-fabricated component from a source to a designated site; a second lifting device for engaging the at least one pre-fabricated component at the designated site; wherein the second lifting device comprises an engagement means to engage a portion of the at least one pre-fabricated component for installation at the designated site, and wherein the engagement means is capable of moving the engaged pre-fabricated component in at least two degrees of motion, is disclosed. In some embodiments, the engagement means comprises a plurality of locks.



SCHEDULE 2

Patents and Patent Applications

Application no	Date filed	Title
10201607958X	23 September 2016	Construction System and Method
PCT/SG2017/050477	21 September 2017	Construction System and Method
106132628	22 September 2017	Construction System and Method

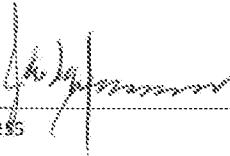


IN WITNESS WHEREOF this Deed has been executed on the date stated at the beginning.

Assignor

SIGNED, SEALED AND DELIVERED by)
TAN YEOW KHOON)
in the presence of:)

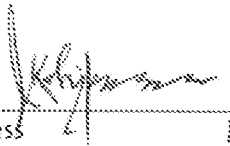



Witness _____ KOH HIONG SAI

Assignee

SIGNED, SEALED AND DELIVERED by)
WALTER TAN MIN LOON)
for and on behalf of)
SH TECHNOLOGIES PTE. LTD.)
in the presence of:)




Witness _____ KOH HIONG SAI

